

DATA IMAGE CORPORATION

LCD Module Specification

ITEM NO.: GM123200SFAYBGI2

Table of Contents

1. COVER & CONTENTS	1
2. RECORD OF REVISION	2
3. GENERAL SPECIFICATIONS	3
4. ABSOLUTE MAXIMUM RATINGS	4
5. ELECTRICAL CHARACTERISTICS	6
6. ELECTRO-OPTICAL CHARACTERISTIC	6
7. TIMING CHARACTERISTICS	9
8. PIN CONNECTIONS	11
9. POWER SUPPLY	11
10. BLOCK DIAGRAM	12
11. QUALITY ASSURANCE	15
12. LOT NUMBERING SYSTEM	19
13. LCM NUMBERING SYSTEM	19
14. PRECAUTION FOR USING LCM	20
15. OUTLINE DRAWING	21
16. PACKAGE INFORMATION	22

Customer Companies	R&D Dept.	Q.C. Dept.	Eng. Dept.	Prod. Dept.
	JACK	ERIC	KEN	HUANG
Approved by	Version:	Issued Date:	Sheet Code:	Total Pages:
	A	2007/1/12		22

2. RECORD OF REVISION

Rev	Date	Item	Page	Comment
A	2007/1/12			New Release

3. GENERAL SPECIFICATION

Display Format : 122dots (W) × 32 (H) dots
Dot Size : 0.4 (W) × 0.45 (H) mm
View Area : 62.2 (W) × 17.9 (H) mm
General Dimensions : 84 (W) × 44 (H) × 14.5 (T) mm Max.
Weight : 36 g max.

LCD Type &
Background Color : STN Blue Gray STN Yellow Green FSTN

Polarizer mode : Reflective Transflective
 Transmissive Negative

View Angle : 6 O'clock 12 O'clock Others _____

Backlight : LED EL CCFL

Backlight Color : Yellow green Amber Blue Green
 White Others

Controller / Driver : SBN1661G-M02

Temperature Range : Normal Wide Temperature
Operating 0 to 50°C Operating -20 to 70°C
Storage -20 to 70°C Storage -30 to 80°C

Pixel Color: Blue

REMARK:

Our components and processes are compliant to ROHS standard.

4. ABSOLUTE MAXIMUM RATINGS

4.1 ELECTRICAL ABSOLUTE MAXIMUM RATINGS

V_{SS}= 0V, Ta = 25°C

Item	Symbol	Min.	Max.	Unit
Supply Voltage (Logic)	V _{DD} -V _{SS}	-0.3	7	V
Supply Voltage (LCD Driver)	V _{DD} -V _{EE}	-0.3	13	V
Input Voltage	V _I	-0.3	V _{DD} +0.3	V
Operating Temperature	T _{OP}	-20	70	°C
Storage Temperature	T _{STG}	-30	80	°C

4.2 ENVIRONMENTAL ABSOLUTE MAXIMUM RATINGS

Item	Operating		Storage		Comment
	(Min.)	Max.)	(Min.)	(Max.)	
Ambient Temp	-20	70	-30	80	Note (1)
Humidity	Note (2)		Note(2)		Without Condensation
Vibration	--	4.9M/S ²	--	19.6M/S ²	XYZ Direction
Shock	--	29.4M/S ²	--	490M/S ²	XYZ Direction

Note(1) Ta = 0°C : 50Hr Max.

Note(2) Ta ≤ 40°C : 90% RH Max.

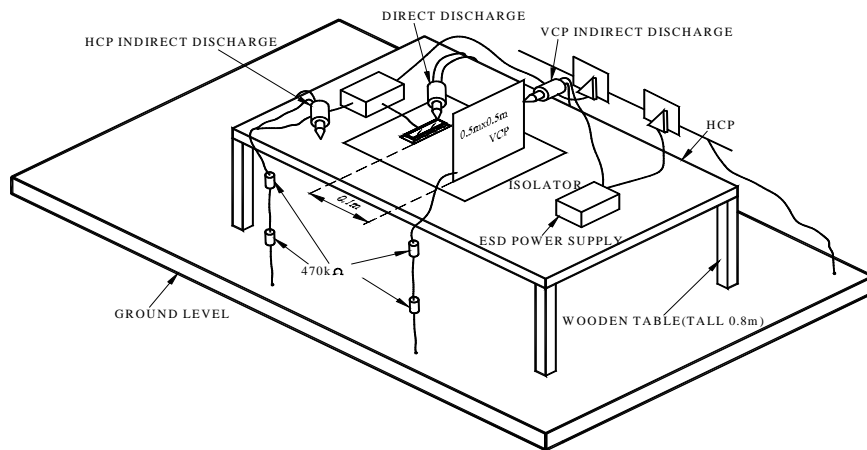
Ta ≥ 40°C : Absolute humidity must be lower than the humidity of 90% RH at 40°C.

4.3 Electronic Static Discharge maximum rating

ESD test method : IEC1000-4-2

Item	Description	
Testing environment	Ambient temperature :15°C to 35 °C Humidity: 30% to 60 % LCM (E.U.T) : Power up	
Testing equipment	Manufacture: Noise Ken, Model No. ESD-100L	
Testing condition	See drawing 1	
Direct discharge	0 to ± 6 KV	Discharge point, see drawing 2
Indirect discharge	0 to ± 12KV	Discharge point, see drawing 1
Pass condition	No malfunction of unit. Temporary malfunction of unit which can be recovered by system reset	
Fail condition	Non. Recoverable malfunction of LCM or system	

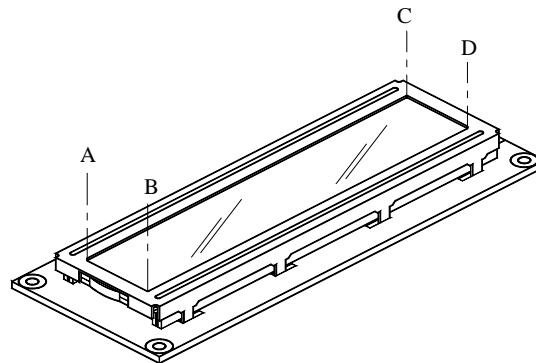
FIG 1 ESD TESTING EQUIPMENT



(1)

DIRECT CONTACT DISCHARGE

CONTACT POINT : A.B.C.D



(2)

5. ELECTRICAL CHARACTERISTICS

Item	Symbol	Condition	Min.	Typ.	Max.	Unit
Supply Voltage (Logic)	VDD-VSS		3.0	5.0	5.5	V
Supply Voltage (LCD)	VDD-VEE	0°C	6.7	7.1	7.4	V
		25°C	6.5	6.9	7.2	
		50°C	6.3	6.7	7.0	
Input Voltage	V _{IH}	--	VDD-1.2	--	VDD	V
	V _{IL}		0	--	0.8	
Logic Supply Current	I _{DD}	VDD-VSS=5V	--	0.3	--	mA

6. ELECTRO-OPTICAL CHARACTERISTICS

ITEM	Symbol	Condition	Min.	Typ.	Max.	Unit	Ref.
Rise Time	Tr	0°C	--	500	800	ms	Note (1)
		25°C		120	240		
Fall Time	Tf	0°C	--	1000	1500	ms	
		25°C		200	350		
Contrast	CR	25°C	3	4	--		Note (3)
View Angle	θ _{1-θ2} ∅ _{1, ∅2}	25°C & CR≥1.5	--	--	80		Note (2)
			-30	--	30		
Frame Frequency	Ff	25°C	--	64	--	Hz	

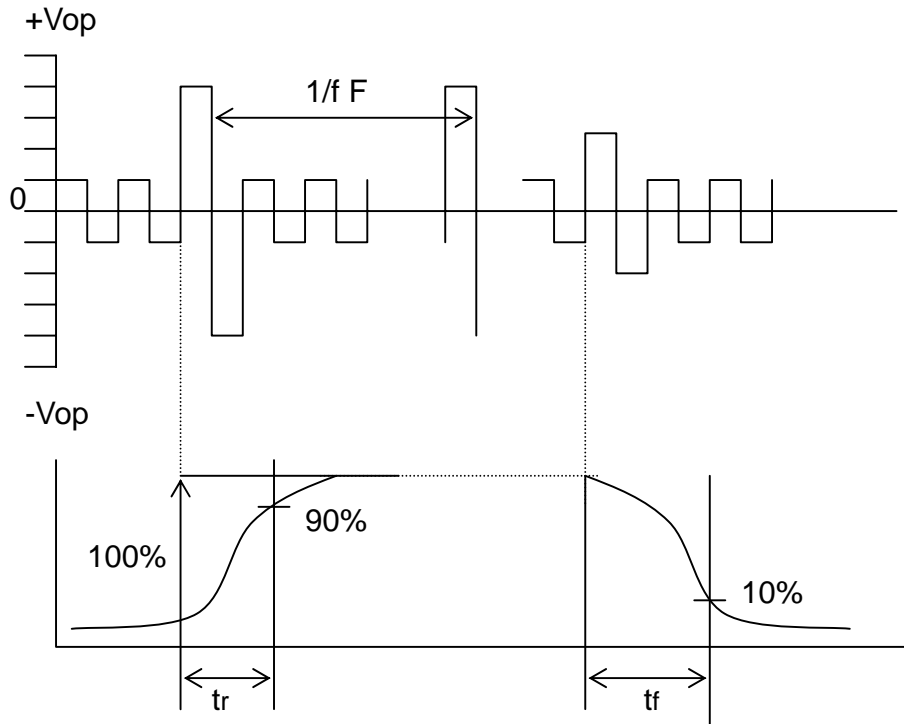
Note (1) & (2) : See next page

Note (3) : Contrast ratio is defined under the following condition:

$$CR = \frac{\text{Brightness of non-selected condition}}{\text{Brightness of selected condition}}$$

- (a). Temperature ----- 25°C
- (b). Frame frequency ---- 64Hz
- (c). Viewing angle ----- θ= 0°, ∅ = 0°
- (d). Operating voltage --- 6.9V

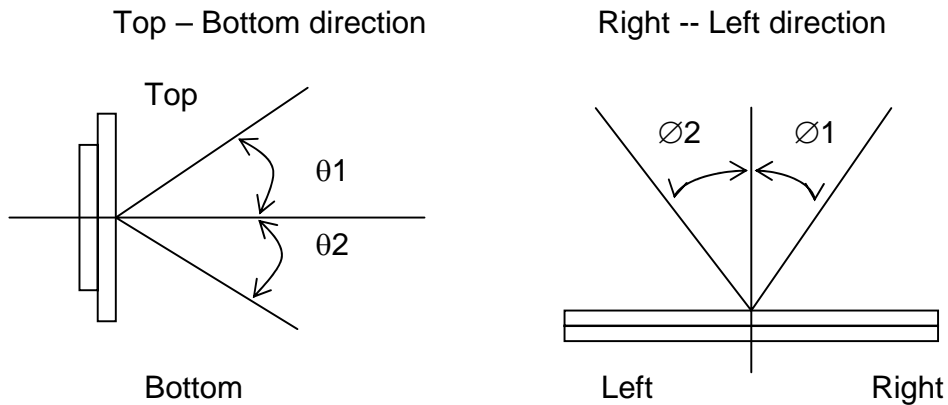
Note (1) Response time is measured as the shortest period of time possible between the change in state of an LCD segment as demonstrated below:



Condition:

- (a) . Temperature -----25°C
- (b) . Frame frequency ----- 64Hz
- (c) . View Angle ----- $\theta = 0^\circ, \phi = 0^\circ$
- (d) . Operating voltage ----- 6.9V

Note (2) Definition of View Angle



6.1 LED ELECTRO-OPTICAL CHARACTERISTIC

Ta = 25°C

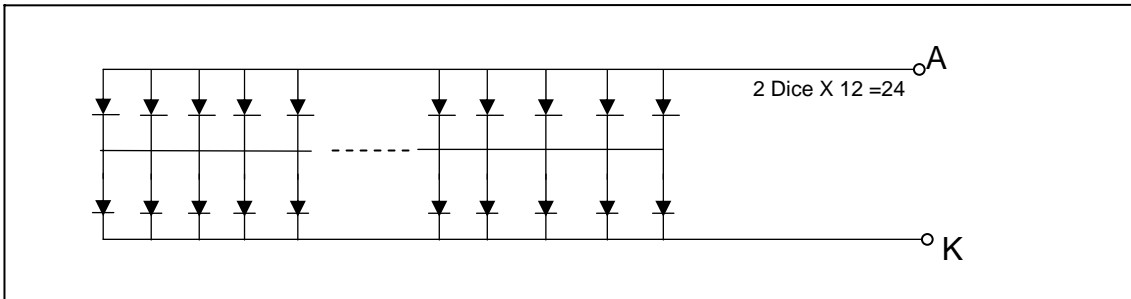
Item	Symbol	Condition	Min.	Typ.	Max.	Unit
Forward Voltage	V _F	IF = 120mA Yellow Green	--	4.1	4.2	V
Luminous Intensity	I _V	IF = 120mA Yellow Green	55	90	--	cd/m ²
Peak Emission	λ _P	IF = 120mA Yellow Green	--	573	--	nm
Spectrum Radiation	Δλ	IF = 120mA Yellow Green	--	30	--	nm
Reverse Current	I _R	VR = 8V Yellow Green	--	--	0.2	mA

Note : Measured at the bared LED backlight unit.

6.2 LED MAXIMUM OPERATING RANGE

Item	Symbol	Yellow Green	Unit
Power Dissipation	P _{AD}	0.76	W
Forward Current	I _{AF}	180	mA
Reverse Voltage	V _R	8	V

6.2.1 LED ARRAY BLOCK DIAGRAM

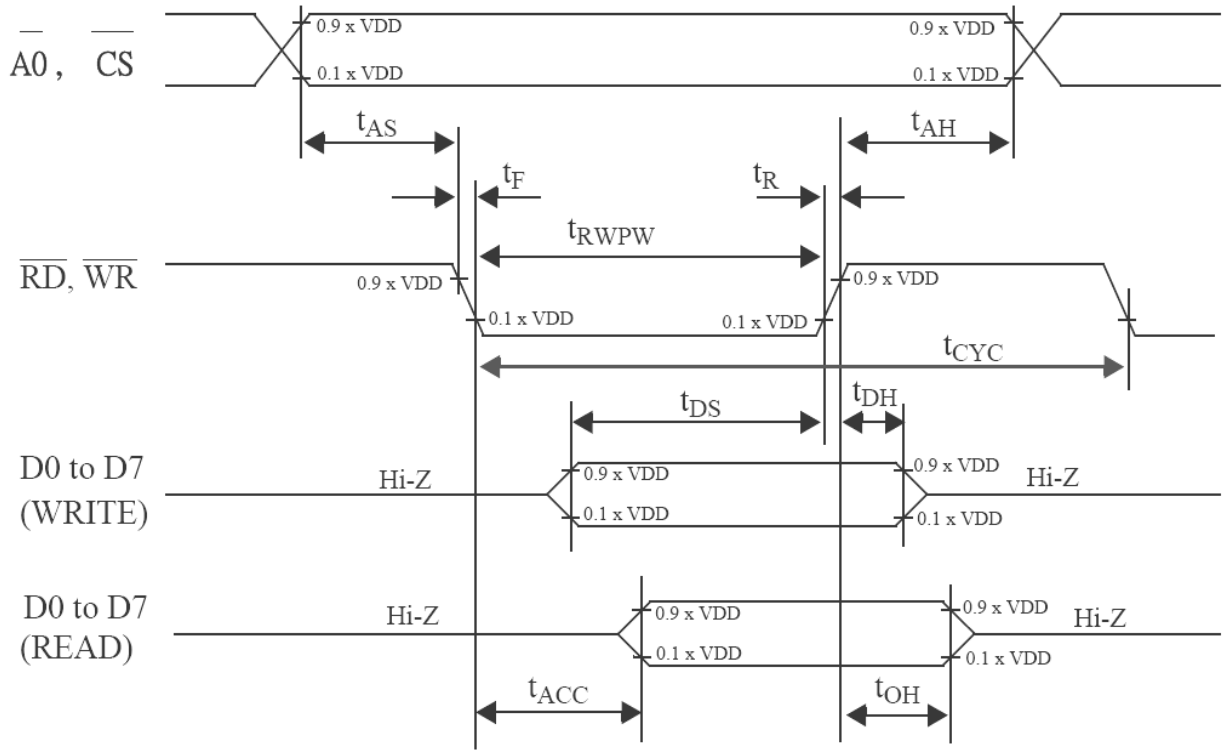


6.2.2 LED POWER SOURCE

	Power source	Jumper setting	Mark
LED	VDD/VSS	J1,J3,R9	
	19A/20K	J2,J4,J5	V
	A/K	NONE	
	19K/20A	J2,J6,J7	
GND	BZL GND	J8	
	FRM GND	J9	

7. TIMING CHARACTERISTICS

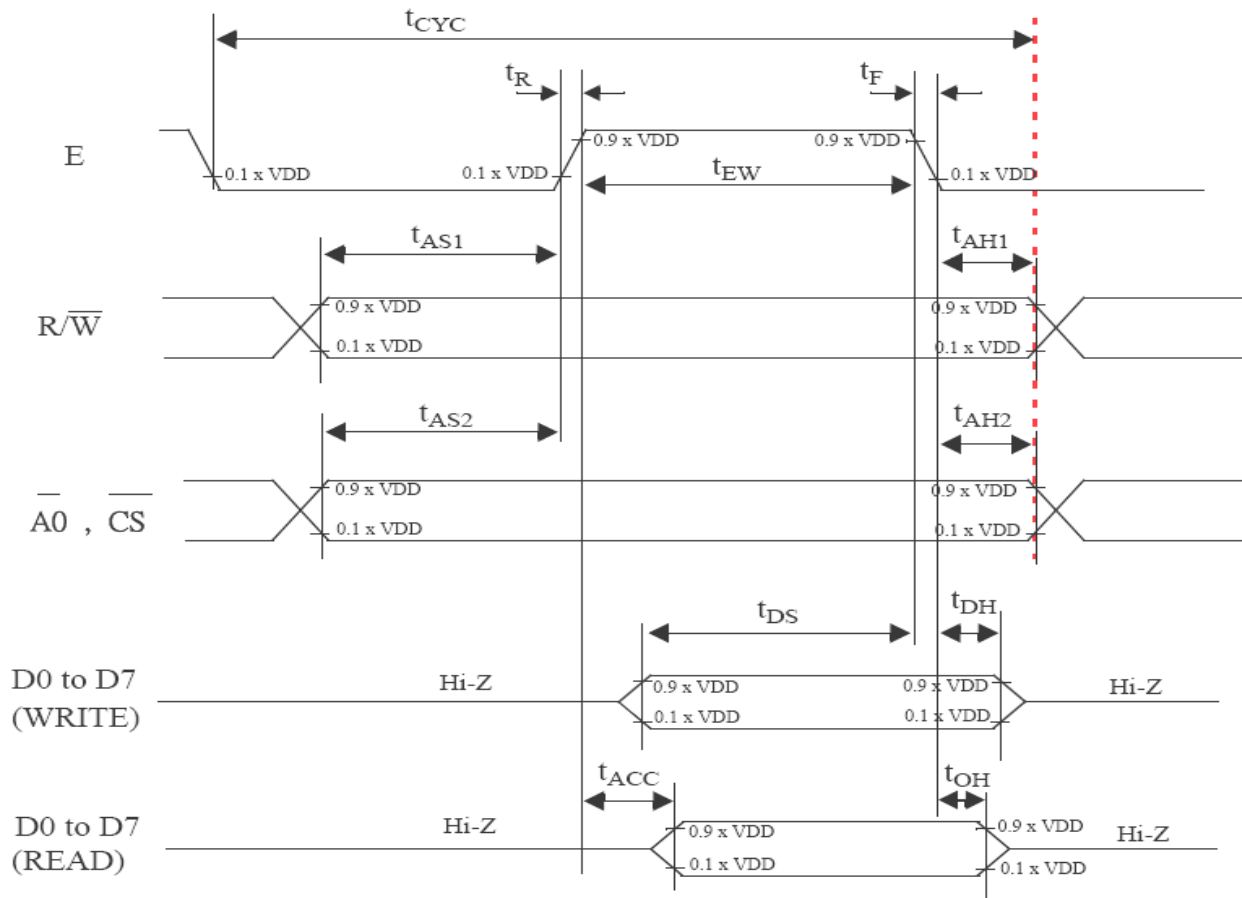
AC Timing for interface with an 80-type microcontroller.



VDD=5V ± 10%;VSS=0V;Ta=-20 to 75° C.

symbol	parameter	min.	max.	test conditons	unit
t_{AS}	Address set-up time	20			ns
t_{AH}	Address hold time	10			ns
t_F, t_R	Read/Write pulse falling/rising time		15		ns
t_{RWPW}	Read/Write pulse width	200			ns
t_{CYC}	System cycle time	1000			ns
t_{DS}	Data setup time	80			ns
t_{DH}	Data hold time	10			ns
t_{ACC}	Data READ access time		90	CL= 100 pF.	ns
t_{OH}	Data READ output hold time	10	60	Refer to Fig. 23.	ns

AC timing for interface a 68-type microcontroller.



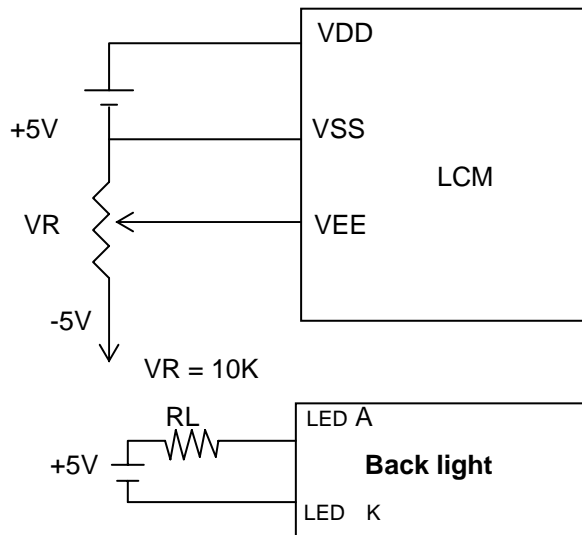
VDD = 5V ± 10% ; VSS=0V; Ta = -20 to 75° C.

symbol	parameter	min.	max.	test conditons	unit
t _{AS1}	Address set-up time with respect to R/W	20			ns
t _{AS2}	Address set-up time with respect to A ₀ , CS	20			ns
t _{AH1}	Address hold time with respect to R/W	10			ns
t _{AH2}	Address hold time respect with to A ₀ , CS	10			ns
t _F , t _R	Enable (E) pulse falling/rising time		15		ns
t _{CYC}	System cycle time	1000		Note 1	ns
t _{EW_R}	Enable pulse width for READ	100			ns
t _{EW_W}	Enable pulse width for WRITE	80			ns
t _{DS}	Data setup time	80			ns
t _{DH}	Data hold time	10			ns
t _{ACC}	Data access time		90	CL= 100 pF.	ns
t _{OH}	Data output hold time	10	60	Refer to Fig. 23.	ns

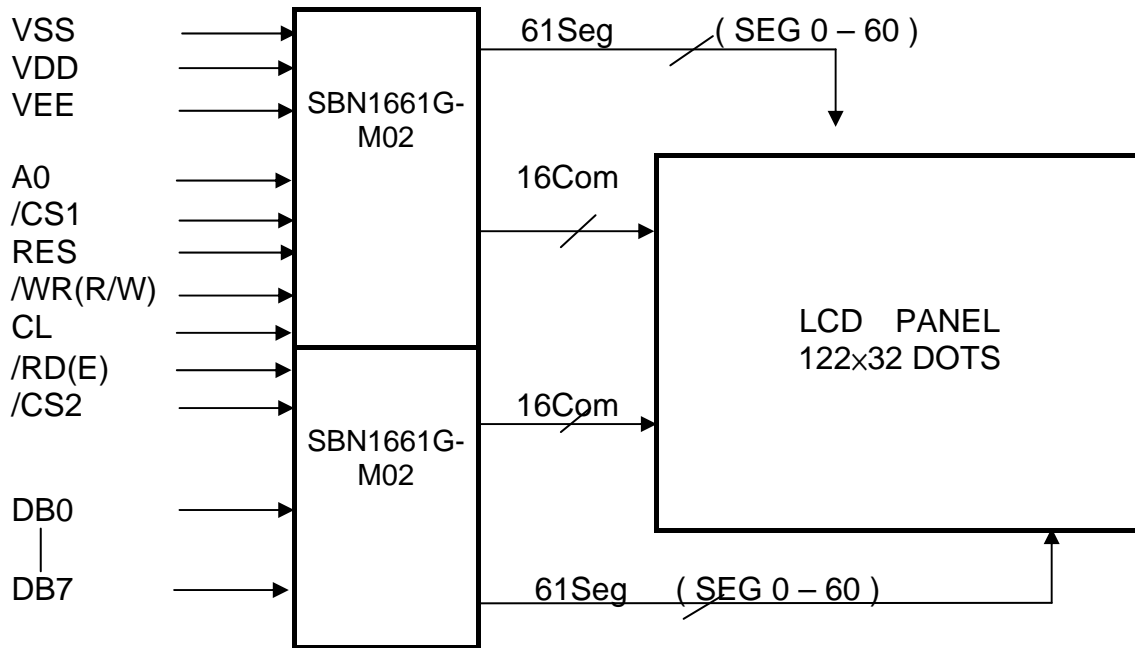
8. PIN CONNECTIONS

No.	Symbol	Function
1	VSS	Ground (0V)
2	VDD	+5V
3	VEE	Power Supply For LCD Drive
4	A0	L→ Instructions H→ Data
5	/CS1	Chip Enable Active "L"
6	/CS2	Chip Enable Active "L"
7	CL	External Clock Input (2K Hz)
8	/RD (E)	/RD for 80 series, E for 68 series
9	/WR (R/W)	/WR for 80 series, R/W for 68 series
10	DB0	Data Bus Line
11	DB1	
12	DB2	
13	DB3	
14	DB4	
15	DB5	
16	DB6	
17	DB7	
18	RES	Reset Signal, H→80 series, L→68 series
19	LED A	LED Anode. Power Supply +
20	LED K	LED Cathode. Power Supply -

9. POWER SUPPLY



10. BLOCK DIAGRAM



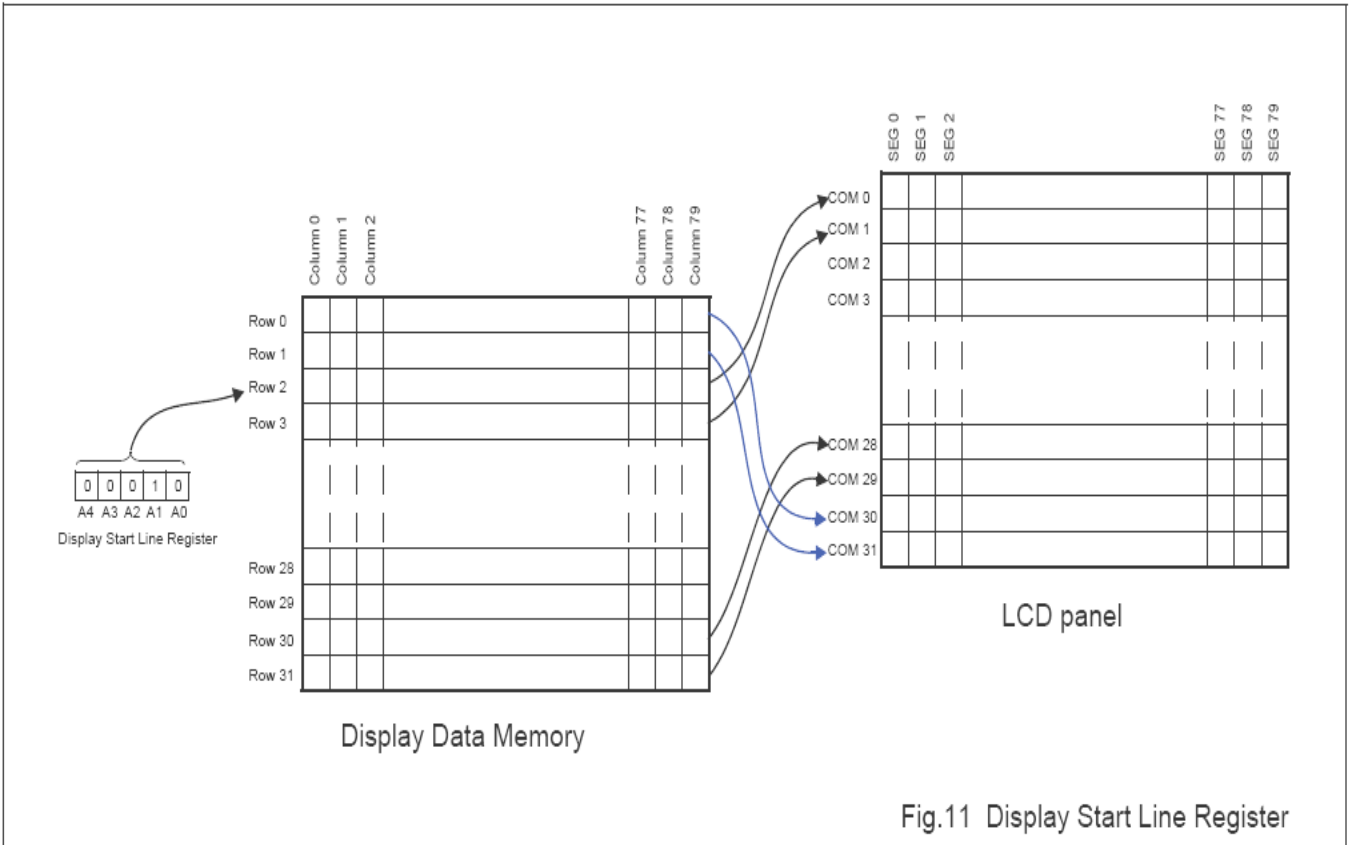


Fig.11 Display Start Line Register

Display Data RAM Addressing

COMMANDS

Summary

Command	Code											Function	
	A0	RD	WR	D7	D6	D5	D4	D3	D2	D1	D0		
Display ON/OFF	0	1	0	1	0	1	0	1	1	1	0/1	Turns display on or off. 1 : ON, 0 : OFF	
Display start line	0	1	0	1	1	0	Display start address (0 to 31)					Specifies RAM line corresponding to top line of display.	
Set page address	0	1	0	1	0	1	1	1	0	Page (0 to 3)		Sets display RAM page in page address register.	
Set column (segment) address	0	1	0	0	Column address (0 to 72)							Sets display RAM column address in column address register.	
Read status	0	0	1	Busy	ADC	ON/OFF	Reset	0	0	0	0	Reads the following status:	
												BUSY	1 : Busy 0 : Ready
												ADC	1 : CW output 0 : CCW output
												ON/OFF	1 : Display off 0 : Display on
												RESET	1 : Being reset 0 : Normal
Write display data	1	1	0	Write data							Writes data from data bus into display RAM.		
Read display data	1	0	1	Read data							Reads data from display RAM onto data bus.		
Select ADC	0	1	0	1	0	1	0	0	0	0	0/1	0 : CW output 1 : CCW output	
Static drive ON/OFF	0	1	0	1	0	1	0	0	1	0	0/1	Selets static driving operation. 1 : Static drive 0 : Normal driving	
Select duty	0	1	0	1	0	1	0	1	0	0	0/1	Selets LCD duty cycle 1 : 1/32 0 : 1/16	
Read – Modify - Write	0	1	0	1	1	1	0	0	0	0	0	Read – modify – write ON	
End	0	1	0	1	1	1	0	1	1	1	0	Read – modify – write OFF	
Reset	0	1	0	1	1	1	0	0	0	1	0	Software reset	

11. QUALITY ASSURANCE

11.1 Test Condition

11.1.1 Temperature and Humidity(Ambient Temperature)

Temperature : $20 \pm 5^{\circ}\text{C}$

Humidity : $65 \pm 5\%$

11.1.2 Operation

Unless specified otherwise, test will be conducted with LCM in operation.

11.1.3 Container

Unless specified otherwise, vibration test will be conducted on module only.

11.1.4 Test Frequency

Single cycle.

11.1.5 Test Method

No.	Parameter	Conditions	Regulations
1	High Temperature Operating	$70 \pm 2^{\circ}\text{C}$	Note 3
2	Low Temperature Operating	$-20 \pm 2^{\circ}\text{C}$	Note 3
3	High Temperature Storage	$80 \pm 2^{\circ}\text{C}$	Note 3
4	Low Temperature Storage	$-30 \pm 2^{\circ}\text{C}$	Note 3
5	Vibration Test (Non-operation state)	Total fixed amplitude : 1.5mm Vibration Frequency : 10 ~ 55Hz One cycle 60 seconds to 3 directions of X.Y.Z. for each 15 minutes	Note 3
6	Damp Proof Test (Non-operation state)	$40^{\circ}\text{C} \pm 2^{\circ}\text{C}$, 90~95%RH, 96h	Note 1,2
7	Shock Test (Non-operation state)	To be measured after dropping from 60cm high once concrete surface in packing state	Note 3

Note 1: Returned under normal temperature and humidity for 4 hrs.

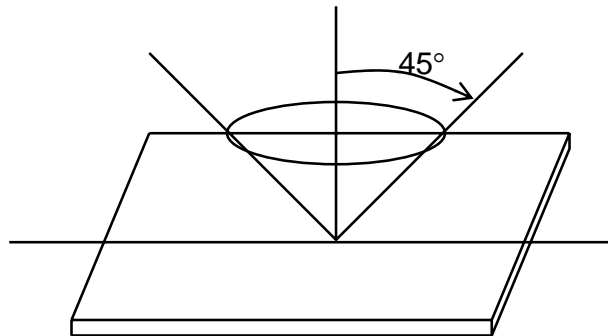
Note 2: No dew condensation to be observed.

Note 3: No change on display and in operation under the test condition

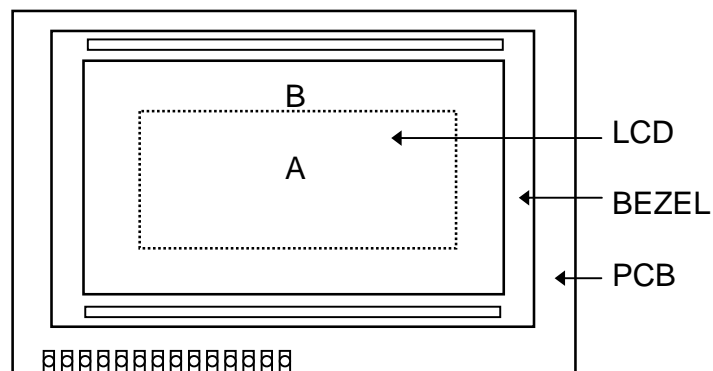
11.2 Inspection condition

11.2.1 Inspection conditions

The LCD shall be inspected under 40W white fluorescent light.



11.2.2 Definition of applicable Zones



A : Display Area
B : Non-Display Area

11.2.3 Inspection Parameters

No.	Parameter	Criteria																												
1	Black or White spots	<table border="1"> <thead> <tr> <th rowspan="2">Zone Dimension</th> <th colspan="2">Acceptable number</th> <th rowspan="2">Class Of Defects</th> <th rowspan="2">AQL Level</th> </tr> <tr> <th>A</th> <th>B</th> </tr> </thead> <tbody> <tr> <td>D < 0.15</td> <td>*</td> <td>*</td> <td rowspan="4">Minor</td> <td rowspan="4">2.5</td> </tr> <tr> <td>0.15 ≤ D < 0.2</td> <td>4</td> <td>4</td> </tr> <tr> <td>0.2 ≤ D ≤ 0.25</td> <td>2</td> <td>2</td> </tr> <tr> <td>D ≤ 0.3</td> <td>0</td> <td>1</td> </tr> </tbody> </table> <p style="text-align: center;">D = (Long + Short) / 2 * : Disregard</p>	Zone Dimension	Acceptable number		Class Of Defects	AQL Level	A	B	D < 0.15	*	*	Minor	2.5	0.15 ≤ D < 0.2	4	4	0.2 ≤ D ≤ 0.25	2	2	D ≤ 0.3	0	1							
Zone Dimension	Acceptable number			Class Of Defects	AQL Level																									
	A	B																												
D < 0.15	*	*	Minor	2.5																										
0.15 ≤ D < 0.2	4	4																												
0.2 ≤ D ≤ 0.25	2	2																												
D ≤ 0.3	0	1																												
2	Scratch, Substances	<table border="1"> <thead> <tr> <th colspan="2">Zone</th> <th colspan="2">Acceptable number</th> <th rowspan="2">Class Of Defects</th> <th rowspan="2">AQL Level</th> </tr> <tr> <th>X (mm)</th> <th>Y (mm)</th> <th>A</th> <th>B</th> </tr> </thead> <tbody> <tr> <td>*</td> <td>0.04 ≥ W</td> <td>*</td> <td>*</td> <td rowspan="4">Minor</td> <td rowspan="4">2.5</td> </tr> <tr> <td>3.0 ≥ L</td> <td>0.06 ≥ W</td> <td>4</td> <td>4</td> </tr> <tr> <td>2.0 ≥ L</td> <td>0.08 ≥ W</td> <td>2</td> <td>3</td> </tr> <tr> <td>—</td> <td>0.1 < W</td> <td>0</td> <td>1</td> </tr> </tbody> </table> <p>X : Length Y : Width * : Disregard Total defects should not exceed 4/module</p>	Zone		Acceptable number		Class Of Defects	AQL Level	X (mm)	Y (mm)	A	B	*	0.04 ≥ W	*	*	Minor	2.5	3.0 ≥ L	0.06 ≥ W	4	4	2.0 ≥ L	0.08 ≥ W	2	3	—	0.1 < W	0	1
Zone		Acceptable number		Class Of Defects	AQL Level																									
X (mm)	Y (mm)	A	B																											
*	0.04 ≥ W	*	*	Minor	2.5																									
3.0 ≥ L	0.06 ≥ W	4	4																											
2.0 ≥ L	0.08 ≥ W	2	3																											
—	0.1 < W	0	1																											
3	Air Bubbles (between glass & polarizer)	<table border="1"> <thead> <tr> <th rowspan="2">Zone Dimension</th> <th colspan="2">Acceptable number</th> <th rowspan="2">Class of Defects</th> <th rowspan="2">AQL Level</th> </tr> <tr> <th>A</th> <th>B</th> </tr> </thead> <tbody> <tr> <td>D ≤ 0.15</td> <td>*</td> <td>*</td> <td rowspan="3">Minor</td> <td rowspan="3">2.5</td> </tr> <tr> <td>0.15 < D ≤ 0.25</td> <td>2</td> <td>*</td> </tr> <tr> <td>0.25 < D</td> <td>0</td> <td>1</td> </tr> </tbody> </table> <p>* : Disregard Total defects shall not excess 3/module.</p>	Zone Dimension	Acceptable number		Class of Defects	AQL Level	A	B	D ≤ 0.15	*	*	Minor	2.5	0.15 < D ≤ 0.25	2	*	0.25 < D	0	1										
Zone Dimension	Acceptable number			Class of Defects	AQL Level																									
	A	B																												
D ≤ 0.15	*	*	Minor	2.5																										
0.15 < D ≤ 0.25	2	*																												
0.25 < D	0	1																												
4	Uniformity of Pixel	<p>(1) Pixel shape (with Dent)</p>																												

4	Uniformity of Pixel	(2) Pixel shape (with Projection)	
		<p>Should not be connected to next pixel</p> <p>0.152</p>	
		(3) Pin hole	
		<p>$(X + Y) / 2 \leq 0.2\text{mm}$</p> <p>(Less than 0.1 mm is no counted)</p>	
		(4) Deformation	
		<p>$(X + Y) / 2 \leq 0.3\text{mm}$</p>	
		Total acceptable number : 1/pixel, 5/cell	
Class of defects	Major	AQL 0.65	Definition It is a defect that is likely to result in failure or to reduce materially the usability of the product for the intended function.
		AQL 1.00	It is a defect that is likely to assembly size and not result in functioning problem.
	Minor	AQL 2.5	It is a defect that will not result in functioning problem with deviation classified.

11.3 Sampling Condition

Unless otherwise agree in written, the sampling inspection shall be applied to the incoming inspection of customer.

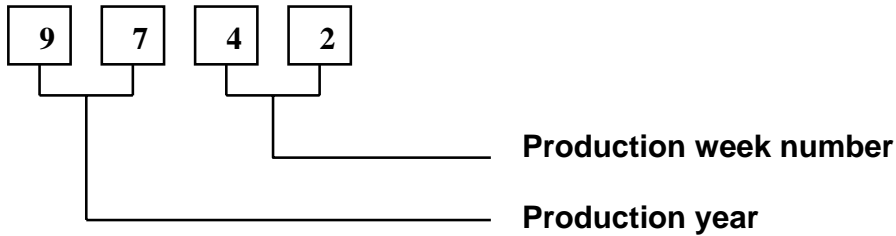
Lot size: Quantity of shipment lot per model.

Sampling type: normal inspection, single sampling

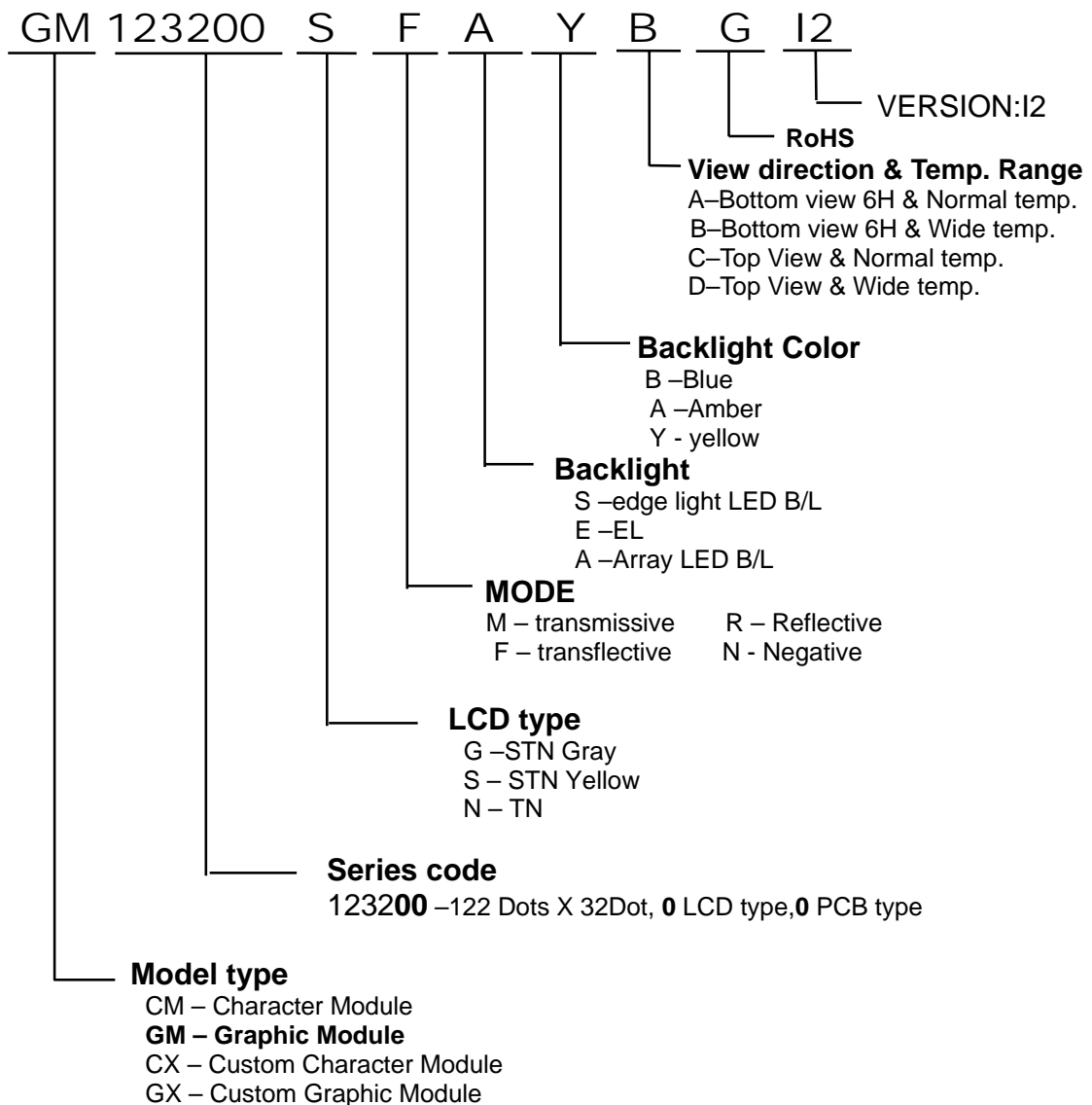
Sampling table: MIL-STD-105E

Inspection level: Level II

12. LOT NUMBERING SYSTEM



13. LCM NUMBERING SYSTEM



14. PRECAUTION FOR USING LCM

1. LIQUID CRYSTAL DISPLAY (LCD)

LCD is made up of glass, organic sealant, organic fluid, and polymer based polarizers. The following precautions should be taken when handling,

- (1). Keep the temperature within range of use and storage. Excessive temperature and humidity could cause polarization degradation, polarizer peel off or bubble.
- (2). Do not contact the exposed polarizers with anything harder than an HB pencil lead. To clean dust off the display surface, wipe gently with cotton, chamois or other soft material soaked in petroleum benzine.
- (3). Wipe off saliva or water drops immediately. Contact with water over a long period of time may cause polarizer deformation or color fading, while an active LCD with water condensation on its surface will cause corrosion of ITO electrodes.
- (4). Glass can be easily chipped or cracked from rough handling, especially at corners and edges.
- (5). Do not drive LCD with DC voltage.

2. Liquid Crystal Display Modules

2.1 Mechanical Considerations

LCM are assembled and adjusted with a high degree of precision. Avoid excessive shocks and do not make any alterations or modifications. The following should be noted.

- (1). Do not tamper in any way with the tabs on the metal frame.
- (2). Do not modify the PCB by drilling extra holes, changing its outline, moving its components or modifying its pattern.
- (3). Do not touch the elastomer connector, especially insert an backlight panel (for example, EL).
- (4). When mounting a LCM make sure that the PCB is not under any stress such as bending or twisting. Elastomer contacts are very delicate and missing pixels could result from slight dislocation of any of the elements.
- (5). Avoid pressing on the metal bezel, otherwise the elastomer connector could be deformed and lose contact, resulting in missing pixels.

2.2. Static Electricity

LCM contains CMOS LSI's and the same precaution for such devices should apply, namely

- (1). The operator should be grounded whenever he/she comes into contact with the module. Never touch any of the conductive parts such as the LSI pads, the copper leads on the PCB and the interface terminals with any parts of the human body.
- (2). The modules should be kept in antistatic bags or other containers resistant to static for storage.
- (3). Only properly grounded soldering irons should be used.
- (4). If an electric screwdriver is used, it should be well grounded and shielded from commutator sparks.

(5) The normal static prevention measures should be observed for work clothes and working benches; for the latter conductive (rubber) mat is recommended.

(6). Since dry air is inductive to statics, a relative humidity of 50-60% is recommended.

2.3 Soldering

- (1). Solder only to the I/O terminals.
- (2). Use only soldering irons with proper grounding and no leakage.
- (3). Soldering temperature : $280^{\circ}\text{C} \pm 10^{\circ}\text{C}$
- (4). Soldering time: 3 to 4 sec.
- (5). Use eutectic solder with resin flux fill.
- (6). If flux is used, the LCD surface should be covered to avoid flux spatters. Flux residue should be removed after wards.

2.4 Operation

- (1). The viewing angle can be adjusted by varying the LCD driving voltage V_0 .
- (2). Driving voltage should be kept within specified range; excess voltage shortens display life.
- (3). Response time increases with decrease in temperature.
- (4). Display may turn black or dark blue at temperatures above its operational range; this is (however not pressing on the viewing area) may cause the segments to appear "fractured".
- (5). Mechanical disturbance during operation (such as pressing on the viewing area) may cause the segments to appear "fractured".

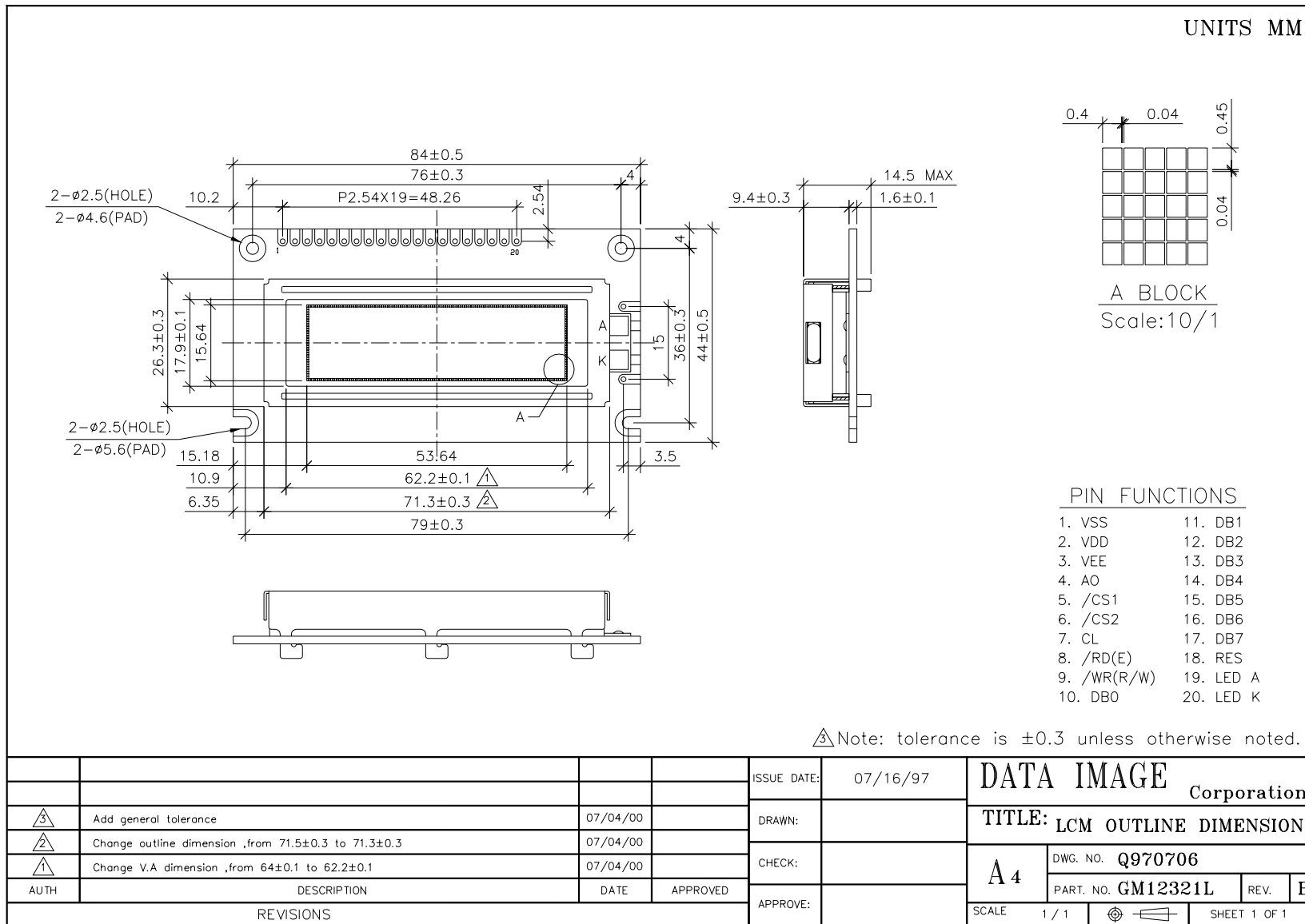
2.5 Storage

If any fluid leaks out of a damaged glass cell, wash off any human part that comes into contact with soap and water. Never swallow the fluid. The toxicity is extremely low but caution should be exercised at all the time.

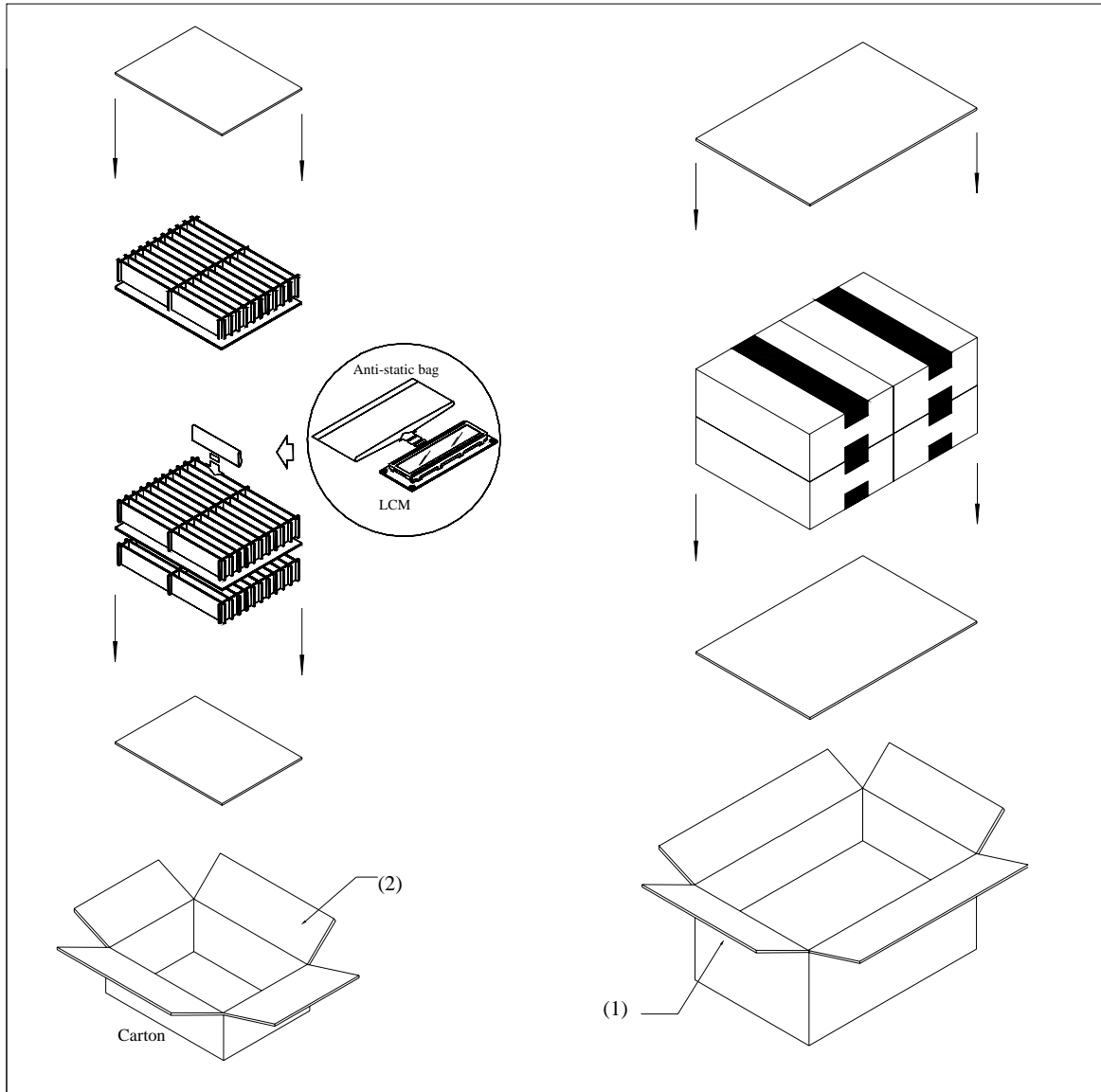
2.6 Limited Warranty

Unless otherwise agreed between DATA IMAGE and customer, DATA IMAGE will replace or repair any of its LCD and LCM which is found to be defective electrically and visually when inspected in accordance with DATA IMAGE acceptance standards, for a period on one year from date of shipment. Confirmation of such date shall be based on freight documents. The warranty liability of DATA IMAGE is limited to repair and/or replacement on the terms set forth above. DATA IMAGE will not responsible for any subsequent or consequential events.

15. OUTLINE DRAWING



16. PACKAGE INFORMATION



Item	Size(L*W*H)		Quantity	Note
1.Master Carton	482*282*279		1	
2.Inner Carton	267*224*115		4	
Quantity Per Inner Carton	48	Quantity Per Master Carton	192	
N . W	6.91 (kg)	G . W	7.91 (kg)	